# Specifications for

# **Blanview TFT-LCD Monitor**

Version 1.0

# MODEL COM57H5M64KSC

	Customer's Approval			
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			SPECIFIC	CATIONS № 12TLM050	3	Issue: Jul. 20, 2012
,	Version Hi	istory				
Γ	Ver.	Date	Page		Description	
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# 1. Application

This Specification is applicable to 14.4cm (5.7 inch) Blanview TFT-LCD monitor for non-military use.

- ORTUS TECHNOLOGY makes no warranty or assume no liability that use of this Product and/or any information including drawings in this Specification by Purchaser is not infringing any patent or other intellectual property rights owned by third parties, and ORTUS TECHNOLOGY shall not grant to Purchaser any right to use any patent or other intellectual property rights owned by third parties. Since this Specification contains ORTUS TECHNOLOGY's confidential information and copy right, Purchaser shall use them with high degree of care to prevent any unauthorized use, disclosure, duplication, publication or dissemination of ORTUS TECHNOLOGY'S confidential information and copy right.
- © If Purchaser intends to use this Products for an application which requires higher level of reliability and/or safety in functionality and/or accuracy such as transport equipment (aircraft, train, automobile, etc.), disaster-prevention/security equipment or various safety equipment, Purchaser shall consult ORTUS TECHNOLOGY on such use in advance.
- This Product shall not be used for application which requires extremely higher level of reliability and/or safety such as aerospace equipment, telecommunication equipment for trunk lines, control equipment for nuclear facilities or life-support medical equipment.
- ORTUS TECHNOLOGY assumes no liability for any damage resulting from misuse, abuse, and/or miss-operation of the Product deviating from the operating conditions and precautions described in the Specification.
- Of any issue arises as to information provided in this Specification or any other information, ORTUS TECHNOLOGY and Purchaser shall discuss them in good faith and seek solution.
- ORTUS TECHNOLOGY assumes no liability for defects such as electrostatic discharge failure occurred during peeling off the protective film or Purchaser's assembly process.

① This Product is compatible for RoHS directive.

Object substance	Maximum content [ppm]
Cadmium and its compound	100
Hexavalent Chromium Compound	1000
Lead & Lead compound	1000
Mercury & Mercury compound	1000
Polybrominated biphenyl series (PBB series)	1000
Polybrominated biphenyl ether series (PBDE series)	1000

# SPECIFICATIONS № 12TLM050

# 2. Outline Specifications

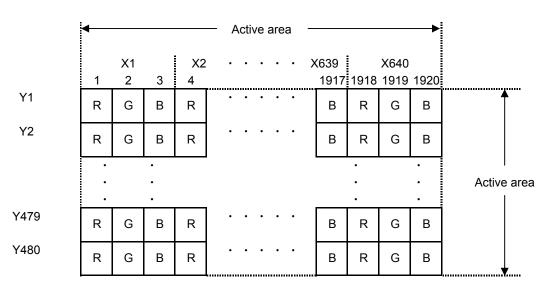
#### 2.1 Features of the Product

- 5.7 inch diagonal display, 1,920 [H] x 480 [V] dots.
- 6-bit 262,144 color display capability.
- 3.3V[TFT-LCD module] is required.
- Built in Timing generator (TG).
- Long life & high brightness LED back-light .
- All-in-one type monitor with lead-free mounting(Response to RoHS Phase 3A).
- Blanview TFT-LCD, improved outdoor readability.

Indoor Outdoor Readability Power Efficiency Readability Power Efficiency (Battery Life) (Battery Life) Transmissive Good Good Fair Poor Transflective Fair Poor Good Good Blanview Good Good Good Good

# 2.2 Display Method

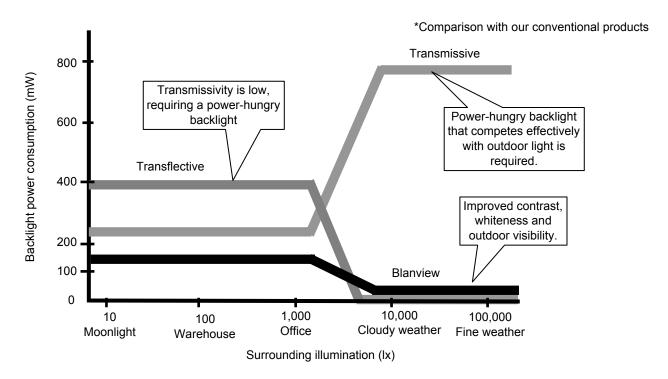
Items	Specifications	Remarks
Display type	TN type 262,144 colors.	
	Transmissive type, Normally white	
Driving method	a-Si TFT Active matrix	
	Line-scanning, Non-interlace	
Dot arrangement	RGB stripe arrangement	Refer to "Dot arrangement"
Signal input method	6-bit RGB, parallel input.	
Backlight type	Long life & High bright white LED.	



Dot arrangement (When FPC is placed at the bottom)

#### <Features of Blanview>

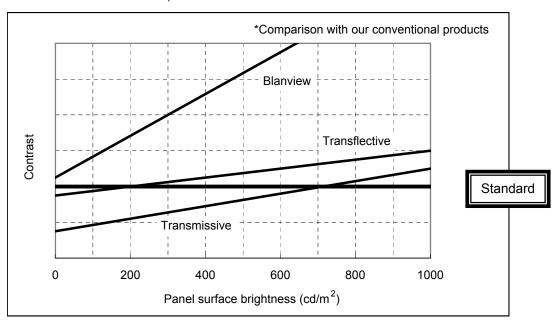
- Backlight power consumption required to assure visibility. (equivalent to 3.5"QVGA)



- Contrast characteristics under 100,000lx. (same condition as direct sunlight.)

With better contrast (higher contrast ratio), Blanview TFT-LCD has the best outdoor readability in three different types of TFT-LCD.

Below chart shows contrast value against panel surface brightness. (Horizontal: Panel surface brightness/ Vertical: Contrast value) LCD panel has enough outdoor readability above our Standard line. (ORTUS TECHNOLOGY criteria)

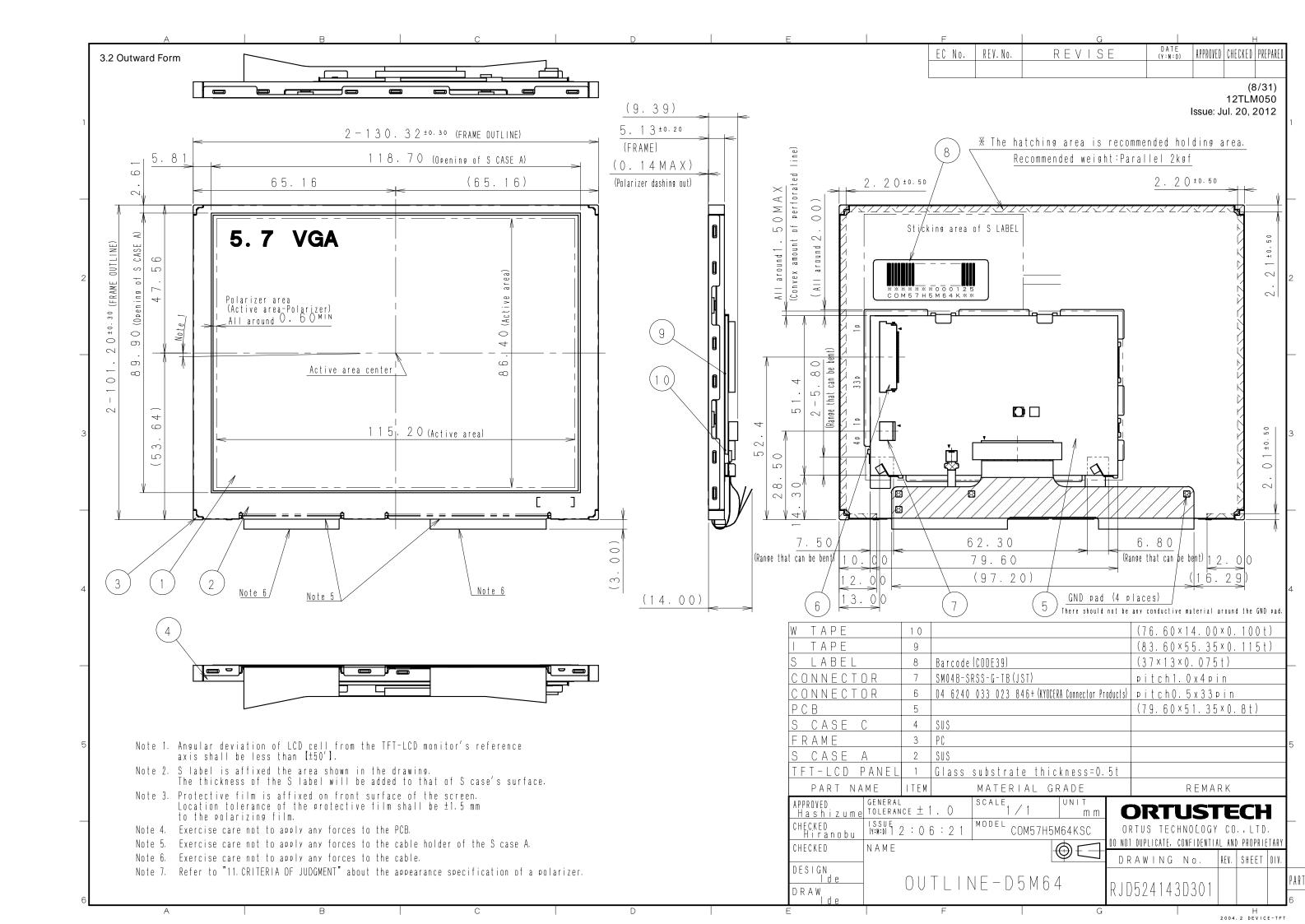


# SPECIFICATIONS № 12TLM050

3. Dimensions and Shape

# 3.1 Dimensions

Items	Specifications	Unit	Remarks
Outline dimensions	130.32[H] × 101.20[V] × 9.39[D]	mm	
Active area	115.20[H] × 86.40[V]	mm	14.4cm diagonal
Number of dots	1,920[H] × 480[V]	dot	
Dot pitch	60.00[H] × 180.00[V]	μm	
Surface hardness of the polarizer	3	Н	Load:2.0N
Weight	122	g	



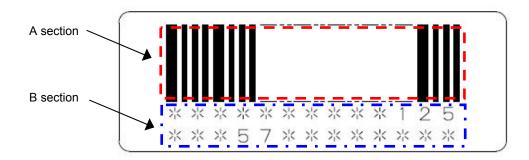
# SPECIFICATIONS № 12TLM050

#### 3.3 SERIAL LABEL (S-LABEL)

#### 1) Display Items

A section : Bar code

B section: Combination of a character



#### Details of B section

Upper culumn: It indicates The least significant digit of manufacture year (1 digit),

manufacture month with below alphabet (1letter), model code (5characters),

serial number (6digits).

\* \* \*\*\*\* \*\*\*\*\* a b c d

Lower culumn: Model (13characters)

	Contents of display								
а	The least significant	digit of n	nanufacture y	ear ear					
b	Manufacture month	Jan-A	Jan-A Mar-C May-E Jul-G Sep-I Nov-K						
		Feb-B	Apr-D	Jun-F	Aug-H	Oct-J	Dec-L		
С	Model code	57DZC	(Made in Jap	oan)					
		57EAC	(Made in Ma	laysia)					
		57EBC (Made in China)							
d	Serial number								

- \* Example of indication of Serial label (S-label)
- · Made in Japan

# 2J57DZC000125

means "manufactured in October 2012, 5.7" DZ type, C specifications, serial number 000125"

· Made in China

# 2J57EBC000125

means "manufactured in October 2012, 5.7" EB type, C specifications, serial number 000125"

2) Location of Serial Label (S-label)

Refer to 3.2 "Outward Form".

2) Others

Bar code readablity is excluded from quality assurance coverage.

·Made in Malaysia

## 2J57EAC000125

means "manufactured in October 2012, 5.7" EA type, C specifications, serial number 000125"

# SPECIFICATIONS № 12TLM050

# 4. Pin Assignment

#### 4.1 Display Module Part

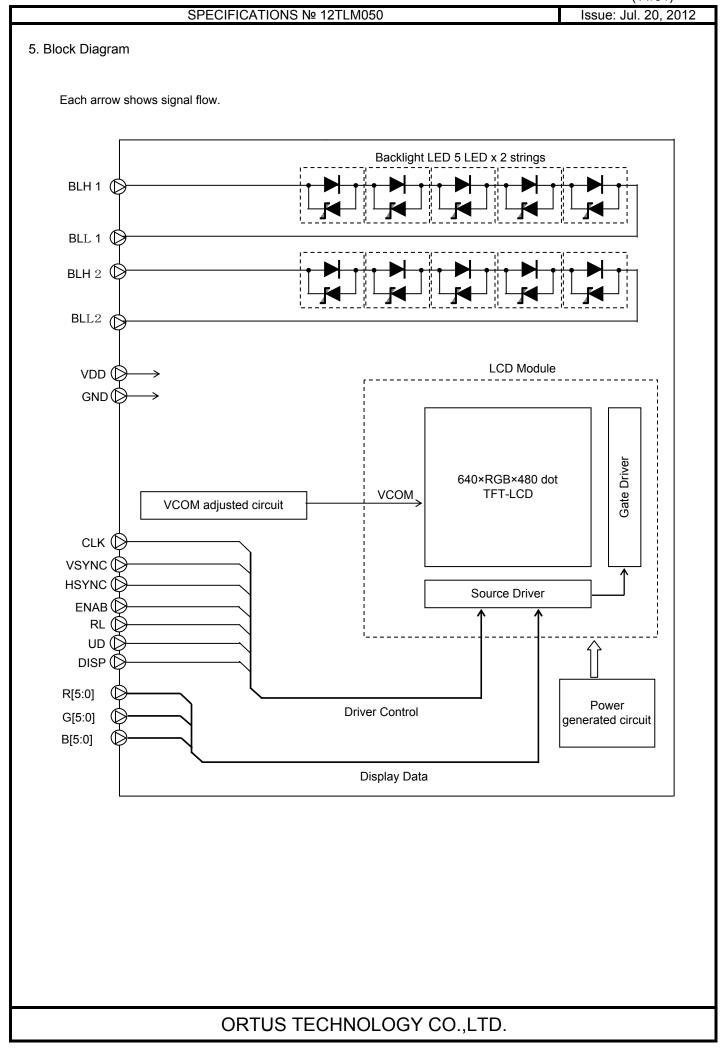
	No.	Symbol	Function	
Horizontal sync signal input.(negative polarity)  Vertical sync signal input.(negative polarity)  Vertical sync signal input.(negative polarity)  Vertical sync signal input.(negative polarity)  Vertically sync signal input.(negative polarity)  Vertically signal input.(negative polarity)  Note2	1	GND	GND.	
4 VSYNC 6 GND 6 R 0 GND 6 R 0 Display data input for (R). 00h for black display R0:LSB R5:MSB Driver IC carries out gamma conversion internally.  10 R 4 11 R5 12 GND GND. 13 G 0 Display data input for (G). 00h for black display R0:LSB R5:MSB Driver IC carries out gamma conversion internally.  10 GND 11 GND 12 GND 13 G 0 Display data input for (G). 00h for black display G0:LSB G5:MSB Driver IC carries out gamma conversion internally.  16 G 3 17 G 4 18 G 5 19 GND 20 B 0 Display data input for (B). 00h for black display G0:LSB G5:MSB Driver IC carries out gamma conversion internally.  17 G 4 18 G 5 19 GND 20 B 0 Display data input for (B). 00h for black display B0:LSB B5:MSB Driver IC carries out gamma conversion internally.  10 Display data input for (B). 00 For black display B0:LSB B5:MSB Driver IC carries out gamma conversion internally.  10 Display data effective signal. (It is effective for the period of "Hi") Power supply input.  11 D Power supply input. 12 Display on/off control signal. (Lo: Horizontally Flipped Display, Hi: Normal display) NOTE1 Display on/off control signal. (Lo: Horizontally Flipped Display) NOTE1 Display on/off control signal. (Lo: display on)	2	CLK	Clock signal.Latching data at the falling edge.	
S	3	HSYNC	Horizontal sync signal input.(negative polarity)	
6 R 0 7 R1 8 R2 9 R3 10 R4 11 R5 12 GND GND. 13 G0 16 G3 17 G4 18 G5 19 GND GND. 20 B0 21 B1 22 B2 23 B3 24 B4 25 B5 26 GND GND. 27 ENAB Input data effective signal. (It is effective for the period of "Hi") 28 VDD Power supply input. 29 VDD Power supply input. 29 VDD Power supply input. 30 RL Horizontally Flipped (irght/left) Signal. (Lo: Horizontally Flipped Display, Hi: Normal display, NOTE1 30 CN F S Si MSB Display data input for (B). 00h for black display B0:LSB B5:MSB Driver IC carries out gamma conversion internally.	4	VSYNC	Vertical sync signal input.(negative polarity)	
7 R 1 8 R 2 9 R 3 10 R 4 11 R 5 11 R 5 12 GND GND. 13 G 0 14 G 1 15 G 2 16 G 3 17 G 4 18 G 5 19 GND 20 B 0 21 B 1 22 B 2 23 B 3 23 B 3 24 B 4 25 B 5 26 GND GND. 27 ENAB Input data effective signal. (It is effective for the period of "Hi") 28 VDD Power supply input. 29 VDD Power supply input. 30 R L Horizontally Flipped (right/left) Signal. (Lo: Horizontally Flipped Display, Hi: Normal display) NOTE1 31 UD Vertically Flipped (right/left) Signal. (Lo: Normal display, Hi: Normal display) NOTE1 32 DISP Display on/off control signal. (Lo: display off, Hi: display on) NOTE2	5	GND	GND.	
8         R 2         R0:LSB         R5:MSB           9         R 3         Driver IC carries out gamma conversion internally.           10         R 4         R5           11         R 5         R5           12         GND         GND.           13         G 0         Display data input for (G).           14         G 1         O0h for black display           15         G 2         G0:LSB         G5:MSB           16         G 3         Driver IC carries out gamma conversion internally.           20         B 0         Display data input for (B).           20         B 0         Display data input for (B).           21         B 1         O0h for black display           80:LSB         B5:MSB           Driver IC carries out gamma conversion internally.           80:LSB         B5:MSB           Driver IC carries out gamma conversion internally.           80:LSB         B5:MSB           Driver IC carries out gamma conversion internally.           80:LSB         B5:MSB           Driver IC carries out gamma conversion internally.           80:LSB         B5:MSB           Driver IC carries out gamma conversion internally.           80:LSB         B6:M	6	R 0	Display data input for (R).	
9 R3 10 R4 111 R5 12 GND GND. 13 G0 Display data input for (G). 14 G1 OOH for black display G0:LSB G5:MSB Driver IC carries out gamma conversion internally.  60 GND.  17 G4 18 G5 19 GND GND. 20 B0 Display data input for (B). 21 B1 OOH for black display G0:LSB G5:MSB Driver IC carries out gamma conversion internally.  17 G4 18 G5 19 GND GND. 20 B0 Display data input for (B). 21 B1 OOH for black display B0:LSB B5:MSB Driver IC carries out gamma conversion internally.  22 B2 23 B3 Driver IC carries out gamma conversion internally.  24 B4 25 B5 26 GND GND.  27 ENAB Input data effective signal. (It is effective for the period of "Hi") 28 VDD Power supply input.  29 VDD Power supply input.  30 RL Horizontally Flipped (right/left) Signal. (Lo: Horizontally Flipped Display, Hi: Normal display) NOTE1 31 UD Vertically Flipped (up/down) Signal. (Lo: Horizontally Flipped Display) NOTE1 32 DISP Display on/off control signal. (Lo: display off, Hi: display on) NOTE2	7	R 1	00h for black display	
10 R 4 11 R 5 12 GND GND. 13 G 0 Display data input for (G). 14 G 1 O0h for black display 15 G 2 GO: LSB G5: MSB 17 G 4 18 G 5 19 GND GND. 20 B 0 Display data input for (B). 21 B 1 O0h for black display 22 B 2 B 2 B0: LSB B5: MSB 23 B 3 Driver IC carries out gamma conversion internally. 24 B 4 25 B 5 26 GND GND. 27 ENAB Input data effective signal. (It is effective for the period of "Hi") 28 VDD Power supply input. 29 VDD Power supply input. 30 RL Horizontally Flipped (right/left) Signal. (Lo: Horizontally Flipped Display) NOTE1 31 UD Vertically Flipped (up/down) Signal. (Lo: Normal display, Hi: Normal display) NOTE1 32 DISP Display on/off control signal.(Lo: display off, Hi: display on)	8	R 2	R0:LSB R5:MSB	
11 R 5 12 GND GND. 13 G 0 Display data input for (G). 14 G 1 O0h for black display 15 G 2 GS ES MSB 16 G 3 Driver IC carries out gamma conversion internally. 17 G 4 18 G 5 19 GND GND. 20 B 0 Display data input for (B). 20 B 0 Display data input for (B). 21 B 1 O0h for black display 22 B 2 B 0 B 0:LSB B5:MSB Driver IC carries out gamma conversion internally. 24 B 4 25 B 5 26 GND GND. 27 ENAB Input data effective signal. (It is effective for the period of "Hi") 28 VDD Power supply input. 29 VDD Power supply input. 30 RL Horizontally Flipped (right/left) Signal. (Lo: Horizontally Flipped Display, Hi: Normal display) NOTE1 31 UD Vertically Flipped (up/down) Signal. (Lo: display off, Hi: display on) NOTE2	9	R 3	Driver IC carries out gamma conversion internally.	
12 GND GND.  13 G 0 Display data input for (G).  14 G 1 O0h for black display  15 G 2 G0:LSB G5:MSB  16 G 3 Driver IC carries out gamma conversion internally.  17 G 4  18 G 5  19 GND GND.  20 B 0 Display data input for (B).  21 B 1 O0h for black display  22 B 2 B 2 B0:LSB B5:MSB  Driver IC carries out gamma conversion internally.  24 B 4 Driver IC carries out gamma conversion internally.  25 B 5  26 GND GND.  27 ENAB Input data effective signal. (It is effective for the period of "Hi")  28 VDD Power supply input.  29 VDD Power supply input.  30 RL Horizontally Flipped (right/left) Signal. (Lo: Horizontally Flipped Display, Hi: Normal display) NOTE1  31 UD Vertically Flipped (up/down) Signal. (Lo: Normal display, Hi: Vertically Flipped Display) NOTE1  32 DISP Display on/off control signal. (Lo: display off, Hi: display on) NOTE2	10	R 4		
13 G 0 Display data input for (G). 14 G 1 O0h for black display 15 G 2 G0:LSB G5:MSB 16 G 3 Driver IC carries out gamma conversion internally.  17 G 4 18 G 5 19 GND GND. 20 B 0 Display data input for (B). 21 B 1 O0h for black display 22 B 2 B 2 Driver IC carries out gamma conversion internally.  23 B 3 Driver IC carries out gamma conversion internally.  24 B 4 25 B 5 26 GND GND.  27 ENAB Input data effective signal. (It is effective for the period of "Hi") 28 VDD Power supply input. 29 VDD Power supply input. 30 RL Horizontally Flipped (right/left) Signal. (Lo: Horizontally Flipped Display, Hi: Normal display) NOTE1 31 UD Vertically Flipped (up/down) Signal. (Lo: Normal display, Hi: Vertically Flipped Display) NOTE1 32 DISP Display on/off control signal. (Lo: display off, Hi: display on) NOTE2	11	R 5		
14 G 1 15 G 2 16 G 3 17 G 4 18 G 5 19 GND GND. 20 B 0 Display data input for (B). 21 B 1 O0h for black display 22 B 2 B 2 B 3 Driver IC carries out gamma conversion internally.  24 B 4 25 B 5 26 GND GND.  27 ENAB Input data effective signal. (It is effective for the period of "Hi") 28 VDD Power supply input. 29 VDD Power supply input. 30 RL Horizontally Flipped (iright/left) Signal. (Lo: Horizontally Flipped Display, Hi: Normal display) NOTE1 31 UD Vertically Flipped (up/down) Signal. (Lo: Normal display, Hi: Vertically Flipped Display) NOTE1 32 DISP Display on/off control signal. (Lo: display off, Hi: display on) NOTE2	12	GND	GND.	
Go:LSB Go:MSB   Driver IC carries out gamma conversion internally.	13	G 0	Display data input for (G).	
Driver IC carries out gamma conversion internally.  Driver IC carries out gamma conversion internally.  Driver IC carries out gamma conversion internally.  Display data input for (B).  Oth for black display  B0:LSB B5:MSB  Driver IC carries out gamma conversion internally.  B0:LSB B5:MSB  Driver IC carries out gamma conversion internally.	14	G 1	00h for black display	
17 G 4 18 G 5 19 GND GND. 20 B 0 Display data input for (B). 21 B 1 O0h for black display 22 B 2 B 0:LSB B5:MSB 23 B 3 Driver IC carries out gamma conversion internally.  24 B 4 25 B 5 26 GND GND. 27 ENAB Input data effective signal. (It is effective for the period of "Hi") 28 VDD Power supply input. 29 VDD Power supply input. 30 RL Horizontally Flipped (right/left) Signal. (Lo: Horizontally Flipped Display, Hi: Normal display) NOTE1 31 UD Vertically Flipped (up/down) Signal. (Lo: Normal display on) NOTE2	15	G 2	G0:LSB G5:MSB	
18 G5 19 GND GND. 20 B 0 Display data input for (B). 21 B 1 O0h for black display B0:LSB B5:MSB Driver IC carries out gamma conversion internally.  24 B 4 25 B 5 26 GND GND.  27 ENAB Input data effective signal. (It is effective for the period of "Hi") 28 VDD Power supply input. 29 VDD Power supply input. 30 RL Horizontally Flipped (right/left) Signal. (Lo: Horizontally Flipped Display, Hi: Normal display) NOTE1 31 UD Vertically Flipped (up/down) Signal. (Lo: Osrmal display, Hi: Vertically Flipped Display) NOTE1 32 DISP Display on/off control signal.(Lo: display off, Hi: display on) NOTE2	16	G 3	Driver IC carries out gamma conversion internally.	
19 GND GND. 20 B 0 Display data input for (B). 21 B 1 O0h for black display 22 B 2 B 3 B 3 Driver IC carries out gamma conversion internally.  24 B 4 25 B 5 Driver IC carries out gamma conversion internally.  27 ENAB Input data effective signal. (It is effective for the period of "Hi")  28 VDD Power supply input.  29 VDD Power supply input.  30 RL Horizontally Flipped (right/left) Signal. (Lo: Horizontally Flipped Display, Hi: Normal display) NOTE1  31 UD Vertically Flipped (up/down) Signal. (Lo: Normal display, Hi: Vertically Flipped Display) NOTE1  32 DISP Display on/off control signal.(Lo: display off, Hi: display on)	17	G 4		
Display data input for (B).  Display data input for (B).	18	G 5		
21 B 1 22 B 2 B 2 B 3 B3 Driver IC carries out gamma conversion internally.  24 B 4 25 B 5 26 GND GND.  27 ENAB Input data effective signal. (It is effective for the period of "Hi") 28 VDD Power supply input.  29 VDD Power supply input.  30 RL Horizontally Flipped (right/left) Signal. (Lo: Horizontally Flipped Display, Hi: Normal display) NOTE1 31 UD Vertically Flipped (up/down) Signal. (Lo: Normal display, Hi: Vertically Flipped Display) NOTE1 32 DISP Display on/off control signal.(Lo: display off, Hi: display on)	19	GND	GND.	
22 B 2 B0:LSB B5:MSB Driver IC carries out gamma conversion internally.  24 B 4 25 B 5  26 GND GND.  27 ENAB Input data effective signal. (It is effective for the period of "Hi")  28 VDD Power supply input.  29 VDD Power supply input.  30 RL Horizontally Flipped (right/left) Signal. (Lo: Horizontally Flipped Display, Hi: Normal display) NOTE1  31 UD Vertically Flipped (up/down) Signal. (Lo: Normal display, Hi: Vertically Flipped Display) NOTE1  32 DISP Display on/off control signal.(Lo: display off, Hi: display on)	20	В0	Display data input for (B).	
Driver IC carries out gamma conversion internally.	21	B 1	00h for black display	
24 B 4 25 B 5 26 GND GND.  27 ENAB Input data effective signal. (It is effective for the period of "Hi") 28 VDD Power supply input. 29 VDD Power supply input. 30 RL Horizontally Flipped (right/left) Signal. (Lo: Horizontally Flipped Display, Hi: Normal display) NOTE1 31 UD Vertically Flipped (up/down) Signal. (Lo: Normal display, Hi: Vertically Flipped Display) NOTE1 32 DISP Display on/off control signal.(Lo: display off, Hi: display on)	22	B 2	B0:LSB B5:MSB	
25 B 5 26 GND GND.  27 ENAB Input data effective signal. (It is effective for the period of "Hi") 28 VDD Power supply input.  29 VDD Power supply input.  30 RL Horizontally Flipped (right/left) Signal. (Lo: Horizontally Flipped Display, Hi: Normal display) NOTE1  31 UD Vertically Flipped (up/down) Signal. (Lo: Normal display,Hi: Vertically Flipped Display) NOTE1  32 DISP Display on/off control signal.(Lo: display off, Hi: display on)	23	B 3	Driver IC carries out gamma conversion internally.	
26 GND GND.  27 ENAB Input data effective signal. (It is effective for the period of "Hi")  28 VDD Power supply input.  29 VDD Power supply input.  30 RL Horizontally Flipped (right/left) Signal. (Lo: Horizontally Flipped Display, Hi: Normal display) NOTE1  31 UD Vertically Flipped (up/down) Signal. (Lo: Normal display,Hi: Vertically Flipped Display) NOTE1  32 DISP Display on/off control signal.(Lo: display off, Hi: display on)	24	B 4		
27 ENAB Input data effective signal. (It is effective for the period of "Hi")  28 VDD Power supply input.  29 VDD Power supply input.  30 RL Horizontally Flipped (right/left) Signal. (Lo: Horizontally Flipped Display, Hi: Normal display) NOTE1  31 UD Vertically Flipped (up/down) Signal. (Lo: Normal display, Hi: Vertically Flipped Display) NOTE1  32 DISP Display on/off control signal. (Lo: display off, Hi: display on) NOTE2	25	B 5		
28 VDD Power supply input. 29 VDD Power supply input. 30 RL Horizontally Flipped (right/left) Signal. (Lo: Horizontally Flipped Display, Hi: Normal display) NOTE1 31 UD Vertically Flipped (up/down) Signal. (Lo: Normal display, Hi: Vertically Flipped Display) NOTE1 32 DISP Display on/off control signal. (Lo: display off, Hi: display on) NOTE2	26	GND	GND.	
29 VDD Power supply input. 30 RL Horizontally Flipped (right/left) Signal. (Lo: Horizontally Flipped Display, Hi: Normal display) NOTE1 31 UD Vertically Flipped (up/down) Signal. (Lo: Normal display,Hi: Vertically Flipped Display) NOTE1 32 DISP Display on/off control signal.(Lo: display off, Hi: display on) NOTE2	27	ENAB	Input data effective signal. (It is effective for the period of "Hi")	
30 RL Horizontally Flipped (right/left) Signal. (Lo: Horizontally Flipped Display, Hi: Normal display) NOTE1 31 UD Vertically Flipped (up/down) Signal. (Lo: Normal display,Hi: Vertically Flipped Display) NOTE1 32 DISP Display on/off control signal. (Lo: display off, Hi: display on) NOTE2	28	VDD	Power supply input.	
31 UD Vertically Flipped (up/down) Signal. (Lo: Normal display,Hi: Vertically Flipped Display) NOTE1 32 DISP Display on/off control signal. (Lo: display off, Hi: display on) NOTE2	29	VDD	Power supply input.	
32 DISP Display on/off control signal.(Lo:display off, Hi:display on) NOTE2	30	RL		NOTE1
	31	UD		NOTE1
33 GND GND	32	DISP	Display on/off control signal.(Lo:display off, Hi:display on)	NOTE2
	33	GND	GND.	

- Used connector
- : KYOCERA Connector Products 6240 series [04 6240 033 023 846+]
- Please refer to the section "3.2 Outward Form" for pin terminal order.
- The corrosion phenomenon by the different kind metal uniting is generated according to the system requirements, and there is a possibility of becoming a loose connection.
   Please select very carefully, and design the FPC cable used.
- NOTE1: If not use , Please let it no connected. NOTE2: If not use , Please let it connected to VDD.

# 4.2 Backlight Part

No.	Symbol	Function
1	BLL2	Backlight drive 2 (cathode side).
2	BLL1	Backlight drive 1 (cathode side).
3	BLH2	Backlight drive 2 (anode side).
4	BLH1	Backlight drive 1 (anode side).

- Used connector: JST [SM04B-SRSS-G-TB(LF)(SN)]
- Please refer to the section "3.2 Outward Form" for pin terminal order.
- The corrosion phenomenon by the different kind metal uniting is generated according to the system requirements, and there is a possibility of becoming a loose connection.
   Please select very carefully, and design the contact used.



#### 6. Absolute Maximum Rating

VSS=0V

Item	Symbol	Condition	Rating		Unit	Applicable terminal
			MIN	MAX		
Supply voltage	VDD	Ta=25°C	-0.3	6.0	V	VDD
Input voltage for logic	VI		-0.3	VDD+0.3	>	CLK,VSYNC,HSYNC,ENAB B[5:0],G[5:0],R[5:0], RL,UD,DISP
LED forward current	IL			70	mA	BLH1-BLL1,BLH2-BLL2
Storage temperature range	Tstg		-30	80	°C	
Storage humidity range	Hstg		Non condensing in an environmental moisture at or less than 40°C90%RH.			

Note: Please input the logic signal after turning on VDD. Do not input the logic signal while blocking VDD.

Absolute maximum ratings is parametric values, should never be exceed any value at any moment.

Beyond which, it could be suffered from changes in characteristics and never be restored .

Moreover, it could even be suffered from permanent destruction.

Therefore, please note enough the fluctuation of input voltage, the characteristics of connected parts,

I/O signal line serge, and ambient temperature, on designing the circuit.

#### 7. Recommended Operating Conditions

VSS=0V

Item	Symbol	Condition	Rating			Unit	Applicable terminal
			MIN	TYP	MAX		
Supply voltage	VDD		3.0	3.3	3.6	V	VDD
Input voltage for logic	VI	VDD=3.0~	0		VDD	V	CLK,VSYNC,
		3.6V					HSYNC,B[5:0],
							G[5:0],R[5:0],
							ENAB,RL,UD,DISP
Operating temperature range	Тор	Note1,2	-30	25	80	°C	Panel surface
							temperature
Operating humidity range		Ta≦40°C	20		85	%	
	Hop	Ta>40°C	Non condensing in				
			an environmental moisture at or				
			less than 40	0°C85%RH			

Note1: The temperature within the display will increase due to the heat radiated from the back light while in operation. Necessary measures have to be taken in the product design to make sure that the display has proper ventilation so that temperature on any surface of this display should not exceed 80 °C.

Note2: This monitor is operatable in this temperature range. With regard to optical characteristics, refer to Item "10. CHARACTERISTICS".

# 8. Characteristics

#### 8.1 DC Characteristics

## 8.1.1 Display Module

(Unless otherwise noted, Ta=25°C,VDD=3.3V,VSS=0V)

Item	Symbol	Condition	Rating			Unit	Applicable terminal
			MIN	TYP	MAX		
Input voltage	VIH		0.7×VDD		VDD	V	CLK,VSYNC,HSYNC,
for logic							ENAB,B[5:0],G[5:0],
	VIL		0		0.3×VDD	V	R[5:0],RL,UD,DISP
Pull down	Rpd		300	450	600	kΩ	ENAB,B[5:0],G[5:0],
resister value							R[5:0]
Pull up	Rpu		300	450	600	kΩ	DISP
resister value							
Current	IDD	fCLK=25MHz		140	280	mA	VDD
consumption		Color bar display					

# 8.1.2 Backlight

Item	Symbol	Condition	Rating		Unit	Applicable terminal	
			MIN	TYP	MAX		
Forward current	IL	Ta=25°C	-	30	70	mA	BLH1 — BLL1
Forward voltage	VL	Ta=25°C, IL= 30 mA		14.0	16.0	V	BLH2 — BLL2
Estimated Life	LL	Ta=25°C, IL= 30 mA		70,000		hr	
of LED		Note					

Note: - The lifetime of the LED is defined as a period till the brightness of the LED decreases to the half of its initial value.

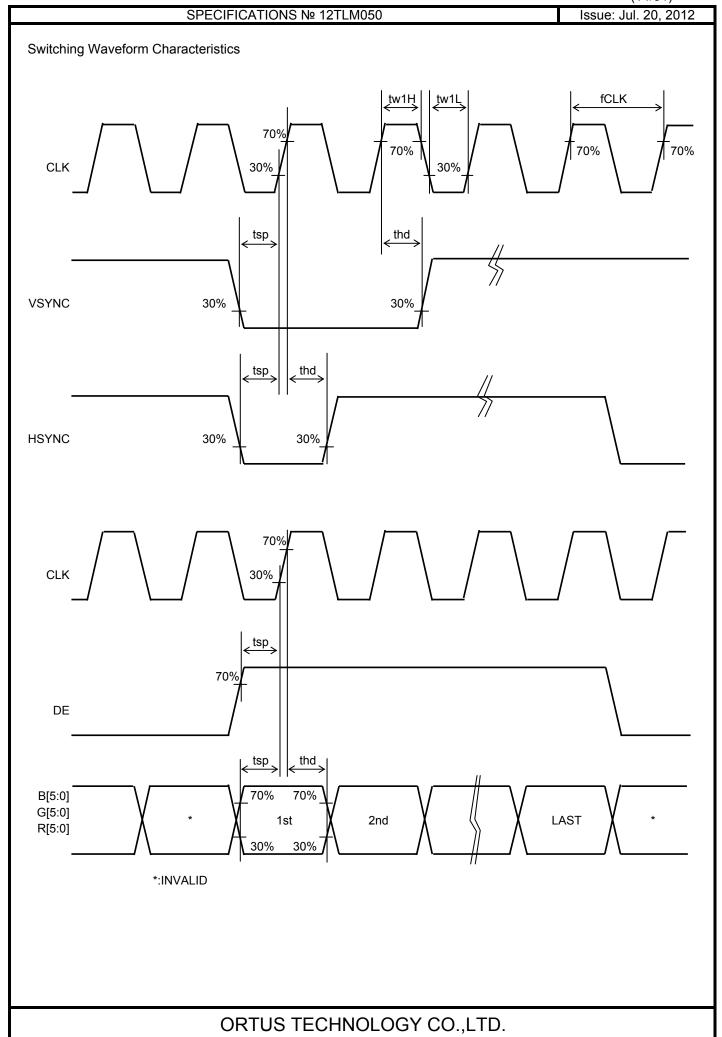
- This figure is given as a reference purpose only, and not as a guarantee.
- This figure is estimated for an LED operating alone.
   As the performance of an LED may differ when assembled as a monitor together with a TFT panel due to different environmental temperature.
- Estimated lifetime could vary on a different temperature and usually higher temperature could reduce the life significantly.

# 8.2 AC Characteristics

#### 8.2.1 Display Module

(Unless otherwise noted, Ta=25°C,VDD=3.3V,VSS=0V)

Item	Symbol	Condition		Rating		Unit	Applicable terminal
			MIN	TYP	MAX		
CLK frequency	fCLK			25	27	MHz	CLK
CLK Low period	tw1L	0.3×VDD or less	14.8			ns	CLK
CLK High period	tw1H	0.7×VDD or more	14.8			ns	CLK
Setup time	tsp		10			ns	CLK,ENAB,B[5:0],
Hold time	thd		10			ns	G[5:0],R[5:0],
							HSYNC,VSYNC



# SPECIFICATIONS № 12TLM050

# 8.3 Input Timing Characteristics

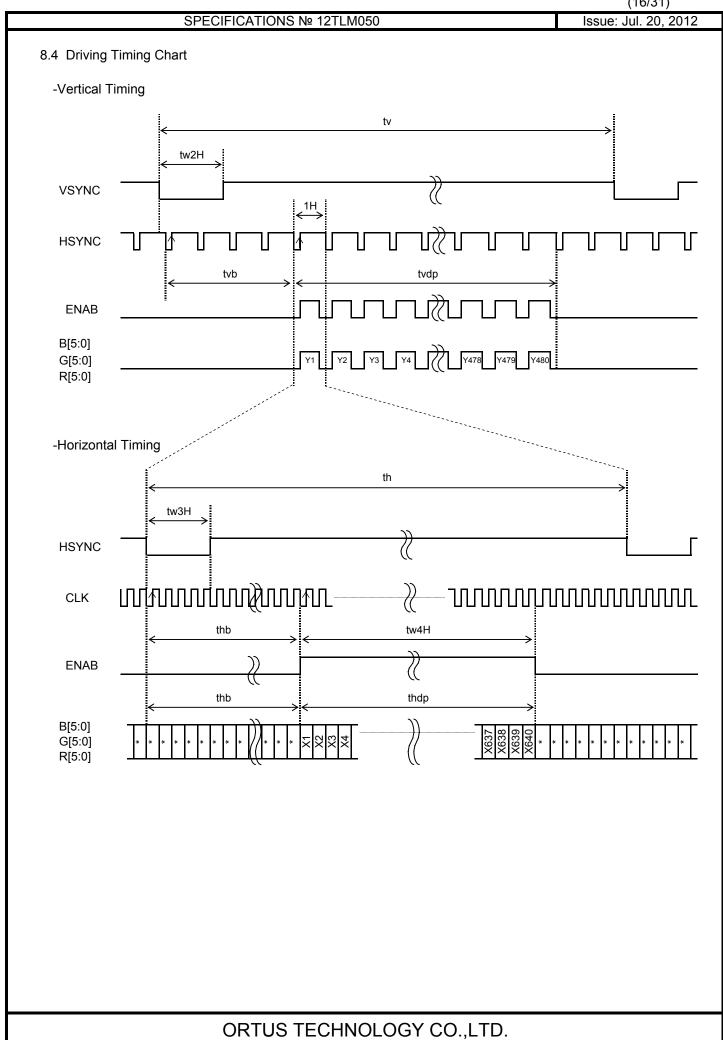
Item	Symbol	Rating			Unit	Applicable terminal
		MIN	TYP	MAX		
CLK frequency	fCLK		25	27	MHz	CLK
VSYNC signal cycle time	tv		525		Н	VSYNC,HSYNC
VSYNC frequency Note1	fVSYNC	54	60	66	Hz	VSYNC
VSYNC pulse width	tw2H	1	3	5	Н	VSYNC,HSYNC
Vartical back porch	tvb		35		Н	VSYNC,HSYNC,ENAB,B[5:0],
Vartical display period	tvdp		480		Н	G[5:0],R[5:0]
HSYNC signal cycle time	th		800		CLK	HSYNC,CLK
HSYNC pulse width	tw3H	5	30		CLK	
Horizontal back porch	thb	112		144	CLK	HSYNC,CLK,ENAB,B[5:0],
				Note 2		G[5:0],R[5:0]
Horizontal display period	thdp		640		CLK	1
DE pulse width	tw4H		640		CLK	ENAB,CLK

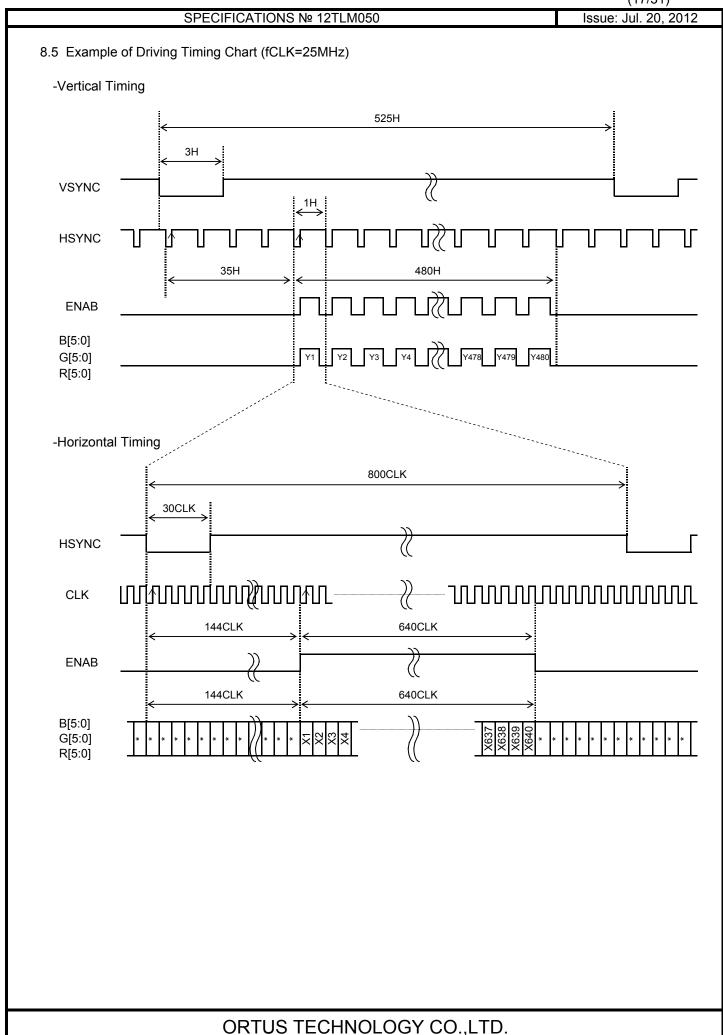
Note1: The characteristic of this item is recommended standard.

Please use it after it confirms it enough like the display fineness etc.

When it comes off from this characteristic and it is used.

Note2: When "ENAB" keeps "Lo" for 144CLK or longer, start capturing data automatically from 144CLK.



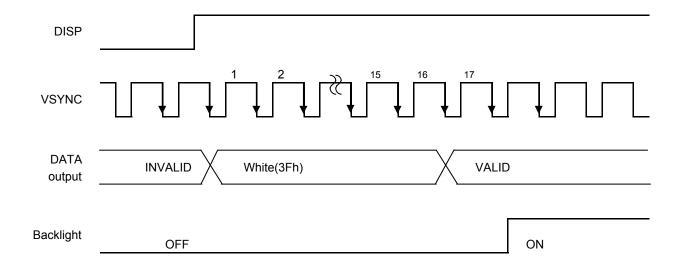


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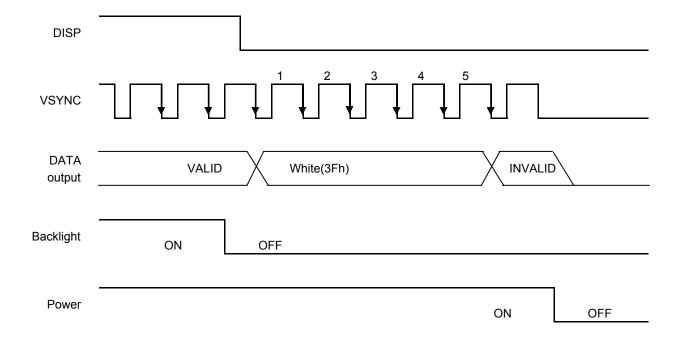
# 9. "DISP" on/off Sequence

It explains the Display on/off sequence.

After Display on, "White" data is outputted for 16-Frames first, from the falling edge of the following VSYNC signal.



After Display off, "White" data is outputted for 5-Frames first, from the falling edge of the following VSYNC signal. Please turn off the power supply promptly after OFF of "DISP".



# SPECIFICATIONS № 12TLM050

# 10. Characteristics

# 10.1 Optical Characteristics

< Measurement Condition >

Measuring instruments: CS1000 (KONICA MINOLTA), LCD7000(OTSUKA ELECTRONICS),

EZcontrast160D (ELDIM)

Driving condition: VDD = 3.3V, VSS = 0V

Optimized VCOMDC

Backlight: IL=30mA Measured temperature: Ta=25°C

	Item	Symbol	Condition	MIN	TYP	MAX	Unit	Note No.	Remark
Response time	Rise time	TON	[Data]= 3Fh→00h	_	_	40	ms	1	*
Resp	Fall time	TOFF	[Data]= 00h→3Fh	_		60	ms		
Contrast ratio	Backlight ON	CR	[Data]= 3Fh/00h	420	700	1		2	
Con	Backlight OFF			_	5.5.	ı			
D	Left	θL	[Data]=	80	80		deg	3	*
Viewing angle	Right	θR	3Fh/00h	80	80	1	deg		
/iev	Up	φU	CR≧10	55	60		deg		
	Down	φD		60	65		deg		
\\/hite	Chromaticity	Х	[Data]=3Fh	White ch	romaticit	y range		4	
VVIIIC	Comomaticity	у							
	Burn-in			No noticeable burn-in image should be observed after 0.5 hours of window pattern display		er 0.5	5		
Cente	Center brightness		[Data]=3Fh	280	400	_	cd/m <sup>2</sup>	6	IL=30mA
				560	800	_			IL=60mA
Brigh	Brightness distribution		[Data]=3Fh	70	_		%	7	

<sup>\*</sup> Note number 1 to 7: Refer to the APPENDIX of "Reference Method for Measuring Optical Characteristics".

X Measured in the form of LCD module.

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0.42 0.40 0.38 0.36 0.36 0.34 0.32 0.32 0.30 0.28 0.28 0.26 0.24 0.22 0.24 0.26 0.28 0.30 0.32 0.34 0.36 0.38 0.40

[White Chromaticity Range]

Х	У
0.26	0.34
0.26	0.28
0.27	0.26
0.33	0.26
0.36	0.31
0.36	0.38
0.35	0.39
0.29	0.39

White Chromaticity Range

# 10.2 Temperature Characteristics

< Measurement Condition >

Measuring instruments: CS1000 (KONICA MINOLTA), LCD7000(OTSUKA ELECTRONICS)

Driving condition: VDD = 3.3V, VSS = 0V

Optimized VCOMDC

Backlight: IL=30mA

Į.	Item		Specif	ication	Remark
'			Ta=-10°C	Ta=70°C	Remark
Contrast ratio		CR	40 or more	40 or more	Backlight ON
Response time	Rise time	TON	200 msec or less	30 msec or less	*
Response time	Fall time	TOFF	300 msec or less	50 msec or less	*
Display Quality			No noticeable display defect or ununiformity should be observed.		Use the criteria for judgment specified in the section 11.

<sup>\*</sup> Measured in the form of LCD module.

# SPECIFICATIONS № 12TLM050

# 11. Criteria of Judgment

# 11.1 Defective Display and Screen Quality

Test Condition: Observed TFT-LCD monitor from front during operation with the following conditions

Driving Signal Raster Patter (RGB in monochrome, white, black)

Signal condition [Data]: 3Fh, 1Ah, 00h (3steps)

Observation distance 30 cm
Illuminance 200 to 350 lx
Backlight IL=30mA

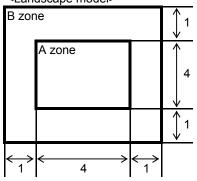
De	Defect item		Defect content	Criteria		
	Line defect	Black, white or color	r line, 3 or more neighboring defective dots	Not exists		
lity		Uneven brightness	on dot-by-dot base due to defective			
Quality		TFT or CF, or dust i	s counted as dot defect			
S	Dot defect	(brighter dot, darker	dot)	Refer to table 1		
Display (	Dot delect	High bright dot: Visi	ble through 2% ND filter at [Data]=00h	Refer to table 1		
Öis		Low bright dot: Visi	ble through 5% ND filter at [Data]=00h			
		Dark dot: Appear da	ark through white display at [Data]=1Ah			
	Dirt	Point-like uneven br	rightness (white stain, black stain etc)	Invisible through 1% ND filter		
>		Point-like	0.25mm<φ	N=0		
Quality	Eoroign		0.20<φ≦0.25mm	N≦2		
g	Foreign particle		φ≦0.20mm	Ignored		
en	particio	Liner	3.0mm <length 0.08mm<width<="" and="" td=""><td>N=0</td></length>	N=0		
Screen			length≦3.0mm or width≦0.08mm	Ignored		
0)	Others			Use boundary sample		
	Outers			for judgment when necessary		

 $\phi$ (mm): Average diameter = (major axis + minor axis)/2 Permissible number: N

Table 1

Table I					
Area	High bright dot	Low bright dot	Dark dot	Total	Criteria
Α	0	2	2	3	Permissible distance between same color bright dots (includes neighboring dots): 3 mm or more
В	2	4	4	6	Permissible distance between same color high bright dots (includes neighboring dots): 5 mm or more
Total	2	4	4	7	

# <Landscape model>



## Division of A and B areas

B area: Active area

Dimensional ratio between A and B areas: 1: 4: 1 (Refer to the left figure)

# SPECIFICATIONS № 12TLM050

11.2 Screen and Other Appearance

Testing conditions

Observation distance 30cm

Illuminance 1200~2000 lx

	Item	Criteria	Remark
Polarizer	Flaw Stain Bubble Dust Dent	Ignore invisible defect when the backlight is on.	Applicable area: Active area only (Refer to the section 3.2 "Outward form")
	S-case	No functional defect occurs	
	Connector	No functional defect occurs	

# 12. Reliability Test

	Test item	Test condition	number of failures		
			/number of examinations		
	High temperature storage	Ta=80°C 240H	0/3		
	Low temperature storage	Low temperature storage Ta=-30°C 240H			
st	High temperature & high	Ta=60°C, RH=90% 240H	0/3		
y te	humidity storage	non condensing			
Durability test	High temperature operation	Tp=70°C 240H	0/3		
ıral	Low temperature operation	Tp=-20°C 240H	0/3		
۵	High temp & humid operation	Tp=40°C, RH=90% 240H	0/3		
	Tilgit terrip & Hurrid Operation	non condensing			
	Thermal shock storage	0/3			
est	Cumfo on disabours to at	C=250pF, R=100Ω, V=±12kV	0/3		
al te	Surface discharge test (Non operation)	Each 5 times of discharge in both polarities			
enta	(Non operation)	on the center of screen with the case grounded.			
J L	Vibration test	Total amplitude 1.5mm, f=10~55Hz, X,Y,Z	0/3		
Mechanical environmental test	Vibration test	directions for each 2 hours			
env		Use ORTUS TECHNOLOGY original jig	0/3		
ä		(see next page)and make an impact with			
anic	Impact test	peak acceleration of 1000m/s2 for 6 msec with			
chs		half sine-curve at 3 times to each X, Y, Z directions			
Me		in conformance with JIS 60068-2-27-2011.			
j,		Acceleration of 19.6m/s <sup>2</sup> with frequency of	0/1 Packing		
tes	Packing vibration-proof test	10→55→10Hz, X,Y, Zdirection for each			
ing		30 minutes			
Packing test	Decking drop toot	Drop from 75cm high.	0/1 Packing		
<u>a</u>	Packing drop test	1 time to each 6 surfaces, 3 edges, 1 corner	_		

Note:Ta=ambient temperature

Tp=Panel temperature

% The profile of high temperature/humidity storage and High Temperature/humidity operation (Pure water of over 10M $\Omega$ ·cm shall be used.)

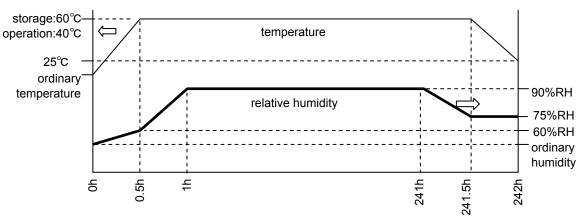


Table2.Reliability Criteria

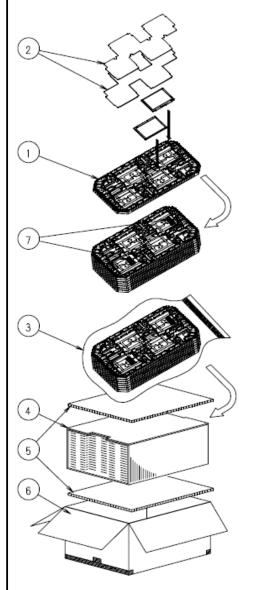
The parameters should be measured after leaving the monitor at the ordinary temperature for 24 hours or more after the test completion.

item	Standard	Remarks
Display quality	No visible abnormality shall be seen.	
Contrast ratio	40 or more	Backlight ON

# (24/31)SPECIFICATIONS № 12TLM050 Issue: Jul. 20, 2012 ORTUS TECHNOLOGY Original Jig $\otimes$ 1mm LCD Monitor LCD Monitor Original jig $\otimes$ - Screw

#### SPECIFICATIONS № 12TLM050

13. Packing Specifications



- Step.1 Each product is to be placed in one of the cut-outs of the tray with the display surface facing upward.(4products per tray) Antistatic foam sheet is to be placed on the products in the tray.
- Step.2 Each tray needs to be same orientation respect to the tray below or above it and the trays be in a stack of 5. One empty tray is to be put on the top of stack of 5 trays.
- Step.3 2 packs of moisture absobers are to be placed on the top tray as shown in the drawing.

Put piled trays into a sealing bag.

Vacuum and seal the sealing bag with the vacuum sealing machine.

- Step.4 The stack of trays in the plastic back is to be inserted into a inner carton.
- Step.5 A corrugated board is to be placed on the top and on the bottom of the inner carton.

The two corrugated boards and the inner carton is to be inserted into an outer carton.

Step.6 The outer carton needs to sealed with packing tape as shown in the drawing.

> The model number, quantity of products, and shipping date are to be printed on the outer carton.

If necessary, shipping labels or impression markings are to be put on the outer carton.

Step.7 The outer carton is to be inserted into a extra outer carton with same direction.

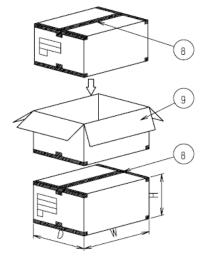
> The extra outer carton needs to sealed with packing tape as shown in the drawing.

Step.8 The model number, quantity of products, and shipping date are to be printed on the extra outer carton

> If necessary, shipping labels or impression markings are to be put on the extra outer carton.



	Packing item name	Specs., Material
1	TRAY	A-PET(Antistatic)
2	FOAM SHEET	Anti-static polyethilene
3	SEALING BAG	
4	INNER CARTON	Corrugated cardboard
(5)	INNER BOARD	Corrugated cardboard
6	OUTER CARTON	Corrugated cardboard
7	Drier	Moisture absorber
8	Packing tape	
9	EXTRA OUTER CARTON	Corrugated cardboard



-			
Dimension of extra outer carton			
D : Approx.	( 338mm )		
W : Approx.	( 549mm )		
H : Approx.	( 198mm )		
Quantity of products	4pcsx5=20pcs		
packed in one carton:			
Gross weight : Approx.	5.9Kg		

14. Handling Instruction

14.1 Cautions for Handling LCD panels



#### Caution

- (1) Do not make an impact on the LCD panel glass because it may break and you may get injured from it.
- (2) If the glass breaks, do not touch it with bare hands.
  (Fragment of broken glass may stick you or you cut yourself on it.
- (3) If you get injured, receive adequate first aid and consult a medial doctor.
- (4) Do not let liquid crystal get into your mouth.
  (If the LCD panel glass breaks, try not let liquid crystal get into your mouth even toxic property of liquid crystal has not been confirmed.
- (5) If liquid crystal adheres, rinse it out thoroughly.
  (If liquid crystal adheres to your cloth or skin, wipe it off with rubbing alcohol or wash it thoroughly with soap. If liquid crystal gets into eyes, rinse it with clean water for at least 15 minutes and consult an eye doctor.
- (6) If you scrap this products, follow a disposal standard of industrial waste that is legally valid in the community, country or territory where you reside.
- (7) Do not connect or disconnect this product while its application products is powered on.
- (8) Do not attempt to disassemble or modify this product as it is precision component.
- (9) For protection your circuit, we recommend you to add excess current protection circuit to power supply.



Caution

This mark is used to indicate a precaution or an instruction which, if not correctly observed, may result in bodily injury, or material damages alone.

SPECIFICATIONS № 12TLM050

14.2 Precautions for Handling

 Wear finger tips at incoming inspection and for handling the TFT monitors to keep display quality and keep the working area clean.
 Do not touch the surface of the monitor as it is easily scratched.

- Wear grounded wrist-straps and use electrostatic neutralization blowers to prevent static charge and discharge when handling the TFT monitors as the LED in this TFT monitors is damageable to electrostatic discharge.
  - Designate an appropriate operating area, and set equipment, tools, and machines properly when handling this product.
- Avoid strong mechanical shock including knocking, hitting or dropping to the TFT monitors for protecting their glass parts. Do not use the TFT monitors that have been experienced dropping or strong mechanical shock.
- 4) Do not use or storage the TFT monitors at high temperature and high humidity environment. Particularly, never use or storage the TFT monitors at a location where condensation builds up.
- 5) Avoid using and storing TFT monitors at a location where they are exposed to direct sunlight or ultraviolet rays to prevent the LCD panels from deterioration by ultraviolet rays.
- Do not stain or damage the contacts of the connector.
   FPC cable needs to be inserted until it can reach to the end of connector slot.
   During insertion, make sure to keep the cable in a horizontal position to avoid an oblique insertion.
   Otherwise, it may cause poor contact or deteriorate reliability of the connector.
- 7) Peel off the protective film on the TFT monitors during mounting process. Refer to the section 14.5 on how to peel off the protective film. We are not responsible for electrostatic discharge failures or other defects occur when peeling off the protective film.
- 8) The volume attached to the monitor is set to the optimal value at the time of shippment from our factory, so please do not change it.

# 14.3 Precautions for Operation

- Since this TFT monitors are not equipped with light shielding for the driver IC,
   do not expose the driver IC to strong lights during operation as it may cause functional failures.
- 2) When turning off the power, turn off the input signal before or at the same timing of switching off the power.
- 3) Do not plug in or out the connector while power supply is switch on. Plug the connector in and out while power supply is switched off.
- 4) Do not operate the TFT monitors in the strong magnetic field. It may break the TFT monitors.
- Do not display a fixed image on the screen for a long time.
   Use a screen-saver or other measures to avoid a fixed image displayed on the screen for a long time.
   Otherwise, it may cause burn-in image on the screen due the characteristics of liquid crystal.

#### SPECIFICATIONS № 12TLM050

#### 14.4 Storage Condition for Shipping Cartons

Storage environment

Temperature 0 to 40°CHumidity 60%RH or less

No-condensing occurs under low temperature with high humidity condition.

Atmosphere No poisonous gas that can erode electronic components and/or wiring

materials should be detected.

Time period 3 months

Unpacking To prevent damages caused by static electricity, anti-static precautionary measures

(e.g. earthing, anti-static mat) should be implemented.

· Maximum piling up 7 cartons

#### 14.5 Precautions for Peeling off the Protective film

The followings work environment and work method are recommended to prevent the TFT monitors from static damage or adhesion of dust when peeling off the protective films.

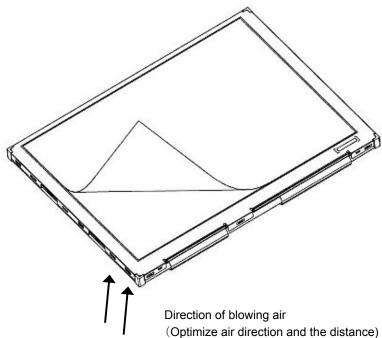
#### A) Work Environment

- a) Humidity: 50 to 70 %RH, Temperature15 to 27°C
- b) Operators should wear conductive shoes, conductive clothes, conductive finger tips and grounded wrist-straps. Anti-static treatment should be implemented to work area's floor.
- c) Use a room shielded against outside dust with sticky floor mat laid at the entrance to eliminate dirt.

#### B) Work Method

The following procedures should taken to prevent the driver ICs from charging and discharging.

- a) Use an electrostatic neutralization blower to blow air on the TFT monitors to its lower left when FPC is placed at the bottom.
  - Optimize direction of the blowing air and the distance between the TFT monitors and the electrostatic neutralization blower.
- b) Put an adhesive tape (Scotch tape, etc) at the lower left corner area of the protective film to prevent scratch on surface of TFT monitors.
- c) Peel off the adhesive tape slowly (spending more than 2 secs to complete) by pulling it to opposite direction.



#### SPECIFICATIONS № 12TLM050

# **APPENDIX**

Reference Method for Measuring Optical Characteristics and Performance

1. Measurement Condition (Backlight ON)

Measuring instruments: CS1000 (KONICA MINOLTA), LCD7000(OTSUKA ELECTRONICS), EZcontrast160D (ELDIM)

Driving condition: Refer to the section "Optical Characteristics"

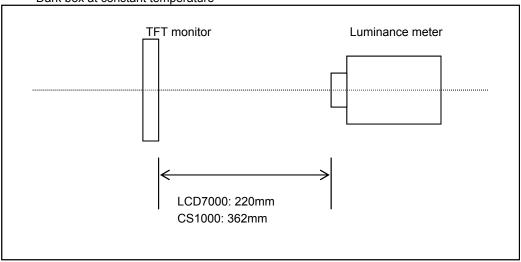
Measured temperature: 25°C unless specified

Measurement system: See the chart below. The luminance meter is placed on the normal line of

measurement system.

Measurement point: At the center of the screen unless otherwise specified

Dark box at constant temperature

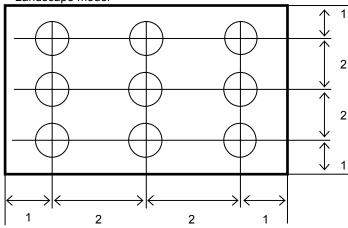


Measurement is made after 30 minutes of lighting of the backlight.

Measurement point: At the center point of the screen

Brightness distribution: 9 points shown in the following drawing.

<Landscape model>



Dimensional ratio of active area

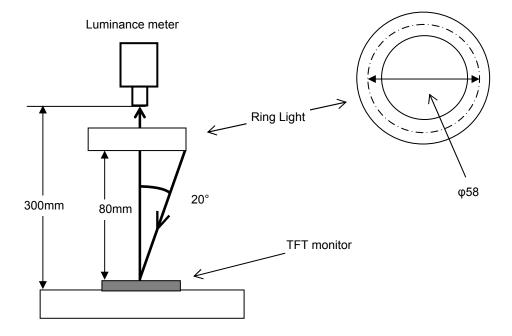
Backlight IL=30mA

Measurement Condition (Contrast ratio Backlight OFF only)

Measuring instruments: LCD7000(OTSUKA ELECTRONICS),Ring Light(40,000 lx,φ58)

Driving condition: Refer to the section "Optical Characteristics"

Measured temperature: 25°C unless specified
Measurement system: See the chart below.
Measurement point: At the center of the screen.



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# 2.

. Test M	_			_
Notic	e Item Test method		Measuring	Remark
			instrument	
1	Response	Measure output signal waveform by the luminance	LCD7000	Black display
	time	meter when raster of window pattern is changed from		[Data]=00h
		white to black and from black to white.		White display
				[Data]=3Fh
				TON
		White Black White		Rise time
				TOFF
				Fall time
				T all tille
		100%		
		l \       /		
		90%		
		10%		
		10%		
		0%		
		Black		
		TON   TOFF		
2	Contrast ratio	Measure maximum luminance Y1([Data]=3Fh) and	CS1000	Backlight ON
		minimum luminance Y2([Data]=00h) at the center of	LCD7000	Backlight OFF
		the screen by displaying raster or window pattern.		
		Then calculate the ratio between these two values.		
		Contrast ratio = Y1/Y2		
		Diameter of measuring point: 8mmφ		
	Viewing	Move the luminance meter from right to left and up	EZcontrast160D	
	angle	and down and determine the angles where		
	Horizontalθ	contrast ratio is 10.		
	Verticalφ			
	White	Measure chromaticity coordinates x and y of CIE1931	CS1000	
	chromaticity	colorimetric system at [Data] = 3Fh		
		Color matching faction: 2°view		
5	Burn-in	Visually check burn-in image on the screen		
		after 0.5 hours of "window display" ([Data]=00h/3Fh).		
6	Center	Measure the brightness at the center of the screen.	CS1000	
	brightness			
7	Brightness	(Brightness distribution) = 100 x B/A %	CS1000	
	distribution	A : max. brightness of the 9 points		
		B : min. brightness of the 9 points		
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